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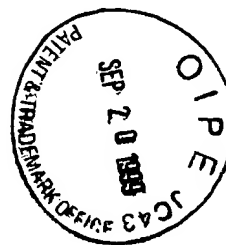
Attorney Docket No. AM1126D1/T08910

Assistant Commissioner for Patents,
Washington, D.C. 20231

on September 16, 1999

TOWNSEND and TOWNSEND and CREW LLP

By [Signature]



IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

In re application of:

KRAMADHATI V. RAVI et al

Serial No.: 09/362,504

Filed: July 27, 1999

For: Method For Reducing The Intrinsic
Stress Of High Density Plasma Films

Examiner: Unassigned

Art Unit: 2812

Batch No.: Unassigned

LETTER TO OFFICIAL DRAFTSPERSON

Assistant Commissioner for Patents
Washington, D.C. 20231

Sir:

Applicant submits 6 sheets of formal drawings to be made of record in the above-identified case.

Respectfully submitted,

[Signature]
Joshua D. Isenberg, Ph.D.
Reg. No. 41,088
Patent Agent

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